

CUSTOMER 客户:

规格书编号

SPEC NO: HDFB03RSBB5SP04

# 产品规格书 SPECIFICATION

_			
PRODUCT 产品:_	SAW FILTER		
MODEL NO 型 号:	HDFB03RSB-B5		
MARKING 印字:_	B053		
PREPARED 编 制:_	CHECKED 审 核:		
APPROVED 批准:_	DATE 日期: 2016-11-25		
客户确认 CUSTOMER RECEIVED:			
审核 CHECKEI	批准 APPROVED	日期 DATE	

# 无锡市好达电子有限公司 Shoulder Electronics Limited

Factory Address: NO. 115, Gaoyun Road, Binhu Economic & Technology Development Area, Wuxi,

Jiangsu, China. Tel: 86-510-85629111

Country of origin: China



# 更改历史记录 History Record

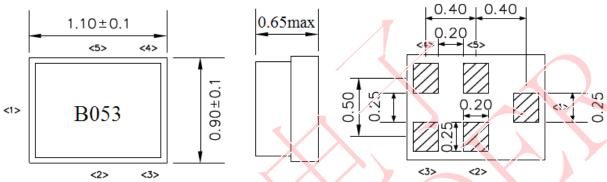
更改日期 Date	规格书编号 Spec. No.	产品型号 Part No.	客户产品型号 Customer No.	更改内容描述 Modify Content	备注 Remark
2015-12-09	SP01	HDFB03RSB -B5		增加平衡100欧姆的匹配电路。	
2016-05-13	SP02	HDFB03RSB -B5		Complete specifications. Add product application, reliability and other information.	
2016-08-23	SP03	HDFB03RSB -B5		Change carrier tape size.  Carrier tape encryption.	10. TAPE SPECIFICATIONS  [Figure 1] Carrier Tape Dimensions
2016-11-25	SP04	HDFB03RSB -B5		Correction device size. Thickness changed from 0.5max. to 0.65max	2. Package Dimension

SAW FILTER HDFB03RSB-B5

## 1. Application

- Low-loss RF filter for mobile telephone WCDMA Band 3 systems.
- Suitable for diversity applications.
- Unbalanced to balanced operation.
- Useable passband 75MHz.
- RoHS compatible.

## **2. DIMENSION** (PKG SIZE 1.1 x 0.9mm)



Unit: mm

Pin configuration 1 Input

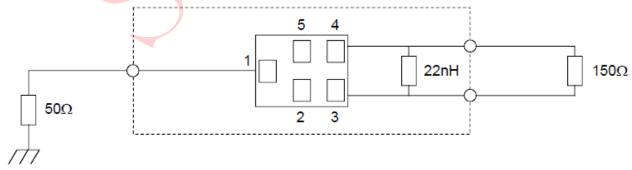
3,4 Balanced Output

2,5 Ground

3. Maximum Rating

Conditions		
-30°C ~+85°C		
-40°C ~ 485°C		
ESD(MM): 50VDC		
ESD(HBM): 175VDC		
5V		
15dBm 2000h		
MSL 2		

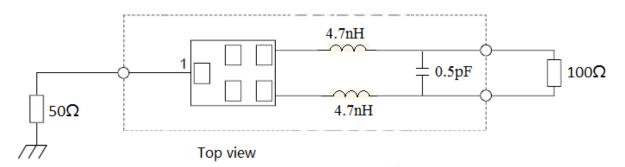
## 4. TEST CIRCUIT



TOP VIEW

**SAW FILTER** 

**OR** 



## 5. ELECTRICAL SPECIFICATION

## **Table 1. Electrical Specification**

Temperature range for specification:  $T = -30 \sim +85^{\circ}C$ 

Terminating source impedance:  $Z_s = 50\Omega$ unbalanced

Terminating load impedance:  $Z_s = 150\Omega$  balanced or  $100\Omega$  balanced

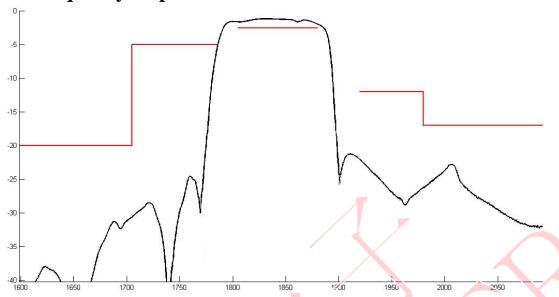
(Please choose according to actual use)

Input signal level: 15dBm 2000h

input signal level.	1302111	2,00011			
Item	Condition Specification		Specification	on	Unit
	(MHz)	Min	Тур	Max	
Insertion loss	1805~1880	-	1.6	2.5	dB
Pass band ripple	1805~1880	<b>(-</b> )	0.7	2.0	dB
VSWR ANT	1805~1880	-	1.8	2.2	-
Rx		-	1.8	2.2	-
Amplitude balance	1805~1880	1	$\pm 0.7$	$\pm 1.5$	dB
Phase balance	1805~1880	l	180±6	$180 \pm 12$	0
	100~1300	35	40	-	-
	1300~1705	20	30	-	dB
Absolute attenuation	1705~1785	5	6	-	dB
	1920~1980	12	15	-	dB
	1980~3000	17	21	-	dB
	3000~4000	40	48	-	dB
	4000~5000	45	50	-	dB
)	5000~6000	27	35	-	dB
	6000~8500	20	40	-	dB



# 6. Typical frequency response



#### 7. ENVIRONMENTAL CHARACTERISTICS

#### 7.1 High temperature exposure

Subject the device to +85°C for 16 hours. Then release the filter into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 5.

#### 7.2 Low temperature exposure

Subject the device to -40°C for 16 hours. Then release the device into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 5.

#### 7.3 Temperature eycling

Subject the device to a low temperature of  $-40^{\circ}$ C for 30 minutes. Following by a high temperature of  $+85^{\circ}$ C for 30 Minutes. Then release the device into the room conditions for 24 hours prior to the measurement. It shall meet the specifications in 5.

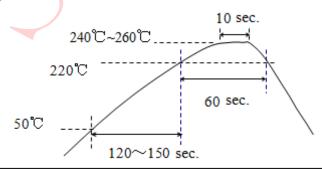
#### 7.4 Resistance to solder heat

- 1, immerge the solder bath at 260°C for 10 sec.
- 2, the iron at 370°C for 3 sec

#### 7.5 Solderability

Submerge the device terminals into the solder bath at  $245^{\circ}$ C  $\pm 5^{\circ}$ C for 5s, More than 95% area of the soldering pad must be covered with new solder. It shall meet the specifications in 5.

#### 7.6 Reflow soldering





SAW FILTER HDFB03RSB-B5

The specimen shall be passed through the reflow furnace with the condition shown in the above profile for 1 time.

The specimen shall be stored at standard atmospheric conditions for 1h, after which the measurement shall be made. Test board shall be 1.6 mm thick. Base material shall be glass fabric base epoxy resin.

#### 7.7 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1m 3 times. the device shall fulfill the specifications in 5.

#### 7.8 Vibration

Subject the device to the vibration for 1 hour each in x,y and z axes with the amplitude of 1.5 mm at 10 to 55 Hz. The device shall fulfill the specifications in 5.

#### 8. REMARK

#### 8.1 Static voltage

Static voltage between signal load & ground may cause deterioration & destruction of the component. Please avoid static voltage.

#### 8.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

#### 8.3 Soldering

Only pad component may be solded. Please avoid soldering another part of component.

## 9. Packing

#### 9.1 Dimensions

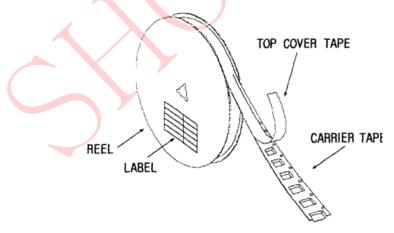
- (1) Carrier Tape: Figure 1
- (2) Reel: Figure 2
- (3) The product shalf be packed properly not to be damaged during transportation and storage.

#### 9.2 Reeling Quantity

10000 pcs/reel φ 178mm

#### 9.3 Taping Structure

(1) The tape shall be wound around the reel in the direction shown below.



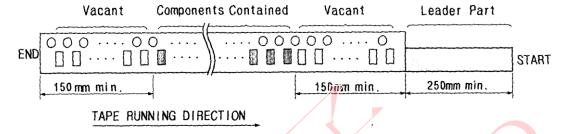
(2) Label



SAW FILTER HDFB03RSB-B5

Device Name	
Marking	
User Product Name	
Quantity	
Lot No.	

(3) Leader part and vacant position specifications.



### 10. TAPE SPECIFICATIONS

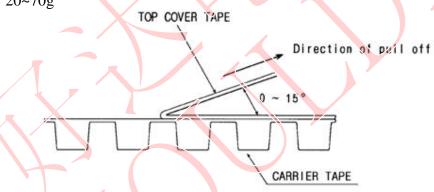
10.1 Tensile Strength of Carrier Tape: 4.4N/mm width

10.2 Top Cover Tape Adhesion (See the below figure)

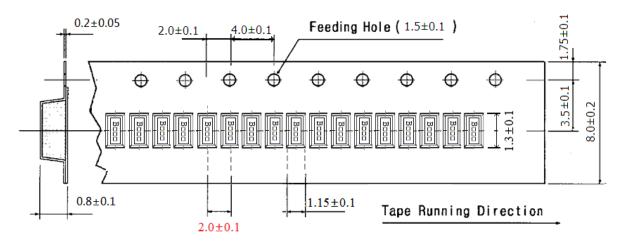
(1) pull off angle: 0~15°

(2) speed: 300mm/min.

(3) force: 20~70g

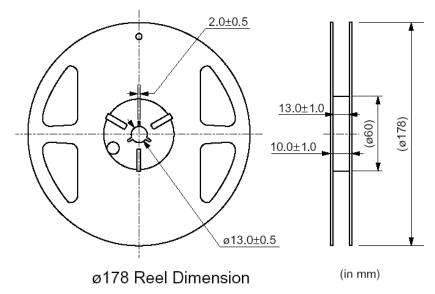


[Figure 1] Carrier Tape Dimensions



Prior to the size of  $4.0\pm0.1$ , after encryption, modified to  $2.0\pm0.1$ .

[Figure 2] 10000 pcs/reel  $\phi$  178mm



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